Bulk and surface states carried supercurrent in ballistic Nb-Dirac semimetal Cd₃As₂ nanowire-Nb junctions

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(Received 1 November 2017; published 27 March 2018)

A three-dimensional Dirac semimetal has bulk Dirac cones in all three momentum directions and Fermi arc like surface states, and can be converted into a Weyl semimetal by breaking time-reversal symmetry. However, the highly conductive bulk state usually hides the electronic transport from the surface state in Dirac semimetal. Here, we demonstrate the supercurrent carried by bulk and surface states in Nb-Cd₃As₂ nanowire-Nb short and long junctions, respectively. For the \sim 1- μ m-long junction, the Fabry-Pérot interferences-induced oscillations of the critical supercurrent are observed, suggesting the ballistic transport of the surface states carried supercurrent, where the bulk states are decoherent and the topologically protected surface states still stay coherent. Moreover, a superconducting dome is observed in the long junction, which is attributed to the enhanced dephasing from the interaction between surface and bulk states as tuning gate voltage to increase the carrier density. The superconductivity of topological semimetal nanowire is promising for braiding of Majorana fermions toward topological quantum computing.

DOI: 10.1103/PhysRevB.97.115446

I. INTRODUCTION

Dirac semimetals are newly emerging three-dimensional (3D) topological materials that possess gapless Dirac dispersions in bulk, protected by time-reversal symmetry and inversion symmetry [1,2]. Cd₃As₂ has been identified to be a 3D Dirac semimetal by angle-resolved photoemission spectroscopy [3,4] and scanning tunneling microscopy [5] experiments. Owing to the unusual band dispersions, Cd₃As₂ exhibits many exotic transport phenomena, such as ultrahigh carrier mobility [6], the chiral anomaly effect [7], and Fermiarc like surface states related quantum oscillations [8–10]. The combination of topological material and superconductor is one of the promising routes toward topological superconductivity [11–14]. A topological superconductor is a crucial state of matter associated with Majorana fermions [15,16], which obey non-Abelian statistics and can provide quantum states that are topologically protected from decoherence. Recently, theoretical investigations have proposed that the Dirac semimetal Cd₃As₂ is promising for topological superconductivity [17,18]. In addition, the signatures of unconventional superconductivity in Cd₃As₂ have been reported through pressure-loaded [19] and point-contacted [20,21] experiments. However, the proximity effect-induced superconductivity in Cd₃As₂ has still not yet been achieved, which is more important for practical devices without complicated pressure loading. On the other hand, the transport properties of the surface states of Dirac semimetal are difficult to be manifested due to the inevitable bulk conductance.

Here, we report the gate voltage, magnetic field, microwave irradiation, and temperature-modulated supercurrent in Nb/Cd₃As₂ nanowire/Nb hybrid structures, taking advantages of the high crystal quality, the large surface-to-volume ratio, and the feasibility of nanoscale device fabrication of Cd₃As₂ nanowires. The surface states carried supercurrent is observed in a junction with \sim 1- μ m channel length, where the bulk states are decoherent and the topologically protected surface states still remain coherent.

II. METHODS

The Cd_3As_2 nanowires were synthesized by chemical vapor deposition method [7]. The transmission electron microscopy (TEM) image shown in Fig. 1(a) indicates the single-crystalline nature of the nanowire. Individual nanowires were transferred to Si substrates with a 285-nm-thick oxide layer. After the process of standard electron-beam lithography, Nb (100 nm)/Pd (5 nm) electrodes were deposited by magnetron sputtering. The thin Pd layer was deposited with the aim to prevent Nb from oxidization. To improve the interface quality, the nanowire surface was etched with Ar-ion sputtering *in situ* before Nb deposition. The scanning electron microscopy (SEM) image in Fig. 1(b) shows the nanowire-Nb junctions. The nanowire diameter is \sim 100 nm. Three junctions with channel length of 100 nm (junction A), 118 nm (junction B), and \sim 1 μ m (junction L) were measured, respectively.

Electrical measurements were carried out in an Oxford Instrument Triton Cryofree dilution refrigerator with a base

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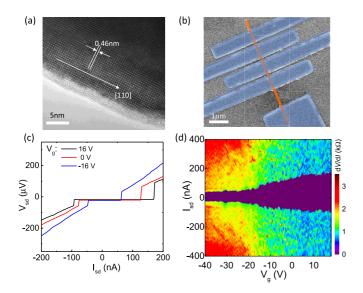


FIG. 1. Characterization of Nb/Cd₃As₂ nanowire/Nb junction. (a) High-resolution TEM image of a typical Cd₃As₂ nanowire, showing the [110] growth direction. (b) SEM image (false color) of the Nb/Cd₃As₂ nanowire/Nb Josephson junctions. The diameter of the nanowire is 100 nm. The interelectrodes separation lengths are 136 nm, 118 nm (junction B), 100 nm (junction A), and 1 μ m (junction L) (from left top to right bottom). (c) The *I-V* characteristics of junction A at different gate voltages. (d) Differential resistance dV/dI on a color scale as a function of source-drain current I_{sd} and gate voltage V_g of junction A. The central purple area corresponds to the superconducting region. The V_g dependence of the critical current I_c can be identified from the upper edge of the purple area. The measurements in (c) and (d) were performed at the base temperature of 12 mK.

temperature of 12 mK. The heavily doped Si substrate and the SiO_2 dielectric together served as a back gate to tune the Fermi level of the nanowire.

III. RESULTS AND DISCUSSION

Figure 1(c) shows the current-voltage (I-V) curves from junction A measured at gate voltages $V_g = 16$, 0, and -16 V, respectively. A clear zero-resistance state and a dissipative state above the critical switching current I_c are observed. The I_c has a close relationship with V_g . Figure 1(d) displays the mapping of the differential resistance dV/dI with V_g and source-drain current I_{sd} . The I_{sd} was swept from negative to positive and the upper boundary of the purple region (the superconducting state) corresponds to I_c . The I_c decreases monotonically when sweeping V_g to lower values. For $V_g < -25 \,\mathrm{V}$, I_c saturates to a small but finite value. The normal-state resistance R_n is extracted at $I_{sd} = 400 \text{ nA}$. The $I_c R_n$ product is nearly constant as a function of gate voltage with a mean value of $115 \,\mu\text{V}$ (see Appendix A), indicating that the Josephson device is in the short-junction limit where the electrode separation is less than the coherence length of the interlayer. Cd₃As₂ nanowire devices fabricated using a similar process but with a long channel length ($\sim \mu$ m) and with Au contacts usually show the Dirac point near 0 V. However, the Dirac point of the short Nb-Cd₃As₂-Nb junction is still not reached at $V_g = -80 \text{ V}$

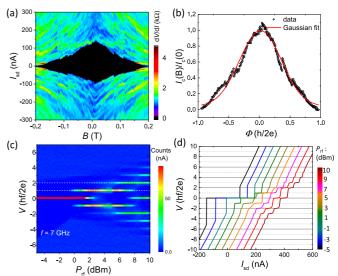


FIG. 2. Josephson effects under perpendicular magnetic field and microwave irradiation. (a) Differential resistance dV/dI on a color scale as a function of magnetic field B and source-drain current I_{sd} for junction A. (b) Normalized critical current I_c (B)/ I_c (0) versus Φ . The red line represents the Gaussian fit. (c) I_{sd} plotted on a color scale as a function of source-drain voltage V and microwave excitation power P_{rf} of junction B (channel length 118 nm) at the rf frequency of 7 GHz. (d) I-V characteristics of junction B under the 7-GHz rf excitation with different power values. The curves are shifted for clarity. Clear Shapiro steps are observed. The measurements were performed at the base temperature of 12 mK.

(see Appendix B). This result suggests that the Nb contacts provide heavy electron doping into the Cd₃As₂ nanowire.

The I_c demonstrates a monotonous decay with increasing the perpendicular magnetic field B [Fig. 2(a)]. Similar behavior has also been observed in InSb nanowire-based Josephson junctions [22]. The magnetic-field dependence of I_c agrees well with a Gaussian fitting [Fig. 2(b)], which is usually observed in narrow Josephson junctions as the junction width (W) is comparable or smaller than the magnetic length ξ_B = $\sqrt{\Phi_0/B}$, where Φ_0 corresponds to the magnetic flux quantum [23–25]. The characteristic magnetic field can be expressed as $B_c = \Phi_0/S$, where S is the junction area perpendicular to the magnetic field. For junction A, the calculated B_c is as large as 0.2 T, which is well consistent with the experimental observations. For $B < B_c$, the magnetic length ξ_B is smaller than the nanowire diameter \sim 100 nm, and the narrow-junction model applies. The mapping of dV/dI as a function of I_{sd} and rf power at 7 GHz is shown in Fig. 2(c). The Shapiro steps are observed at V = nhf/(2e) [Fig. 2(d)], where h is Plank's constant, f is the microwave frequency, and n is an integer. The odd as well as even steps are observed up to n = 5, revealing a dominant 2π -periodic contribution to the current-phase relation. Although the topological superconductivity would lead to a 4π -periodic Josephson supercurrent, its absence in experiments is also understandable, because the supercurrent amplitude of the 4π period is much smaller than that of the 2π period. Moreover, the 4π -periodic supercurrent is sensitive to the quasiparticle scattering and the transparency of the interface [26,27]. Further optimizing the device interface

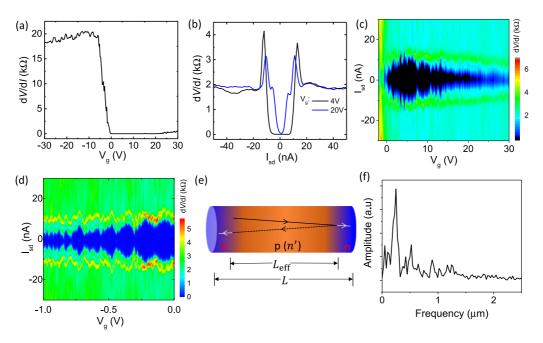


FIG. 3. Josephson supercurrent of junction L (channel length $1 \, \mu m$). (a) Differential resistance as a function of gate voltage at $I_{sd} = 0 \, \text{nA}$ with an excitation current $I_{ac} = 2 \, \text{nA}$. The supercurrent exists in the V_g region of $0 \sim 20 \, \text{V}$, while at negative gate voltages, the resistance increases sharply. (b) Differential resistance dV/dI as a function of source-drain current I_{sd} at $V_g = 4$ and $20 \, \text{V}$. (c) Differential resistance dV/dI on a color scale as a function of I_{sd} and V_g . The central dark area corresponds to the superconducting region. (d) Elaborate measurements of dV/dI as a function of I_{sd} and V_g in the region of $-1 \sim 0 \, \text{V}$. I_c oscillations are observed clearly. (e) Sketch of the Fabry-Perot resonator in the nanowire between two Nb contacts. (f) FFT analysis of the $I_c(k_f)$ oscillation. The FFT peak F = 0.249 corresponds to an oscillation period $\Delta k_f \sim 4.01 \, \mu m^{-1}$.

and the measurement conditions would help to reveal the 4π -periodic supercurrent.

To reduce the influence of electron doping from the Nb contacts, a long junction (junction L) with a channel length \sim 1 μ m was studied. Figure 3(a) displays the V_g dependence of dV/dI measured at an excitation current $I_{ac} = 2$ nA. Clearly, the long junction still demonstrates supercurrent in the V_g region of 0 to 20 V. While tuning V_g below 0 V, the resistance increases dramatically and the supercurrent disappears. Also for $V_g > 20 \,\mathrm{V}$, a nonzero-resistance state emerges, showing dissipative transport. The gate switchable supercurrent indicates that there are different conduction channels depending on the Fermi level of the nanowire. The critical current is \sim 10 nA at $V_g = 4$ V, which almost decreases to 0 at $V_g = 20$ V [Fig. 3(b)]. The overall evolution of dV/dI with V_g and I_{sd} is exhibited in Fig. 3(c). The I_c has its maximum at around $V_g = 4 \text{ V}$. Such a convex behavior of I_c as a function of gate voltage is very different from the concave behavior as observed in graphene [28,29] and InAs nanowire [30]-based Josephson junctions. Generally, the I_c should increase with increasing the electron concentration, such as the behavior in the 100-nm short junction A [Fig. 1(d)]. Interestingly, Fig. 3(c) shows that the I_c decreases with increasing V_g away from 4 V, reminding one of the superconductivity dome phenomena [31–35]. The dome-shaped superconductivity is not restricted in oxide compounds, such as Na-doped WO₃ [31], KTaO₃ [32], and LaAlO₃/SiTiO₃ interface [33], but also occurs in a band insulator, MoS₂ [34]. However, the mechanism behind the superconductivity dome is still under debate. It is attributed to the phonon softening from a structural transition in Na-doped WO₃ [31], and the quantum critical point in KTaO₃ and LaAlO₃/SiTiO₃ interface [32,33], while Jianting Ye et al. believed that there is a more universal and nonmaterial-related mechanism for the superconducting dome [34]. Considering the existence of both bulk and surface states in the Dirac semimetal nanowires, we proposed a mechanism related to the bulk-surface states interaction-induced dephasing for the observed superconducting dome. Liao et al. [36] have reported the enhanced electron dephasing due to the coupling between surface states and charge puddles in the bulk in a 3D topological insulator. In Dirac semimetals, there is a highly conductive bulk state, and the scatterings between surface and bulk states would produce significant dephasing. With tuning the gate voltage to increase the electron density, the interaction between bulk and surface states will be enhanced. It destroys the coherent transport of the Cooper pairs and the supercurrent.

Unambiguous oscillations of I_c as function of gate voltage are observed. The rich pattern of dV/dI as a function of I_{sd} and V_g in the region of $-1 < V_g < 0\,\mathrm{V}$ is shown in Fig. 3(d). The oscillation may be attributed to a Fabry-Perot (FP) interference [37–39]. Due to the electron-doping effect near the Nb contacts, n-p walls may be formed near the contacts [Fig. 3(e)] as the central part of the channel is tuned into the hole dominant region by gate voltage. The barrier and reduced transmission probability near the contacts lead to the partial reflection of carriers and the formation of a FP cavity. The modulation of the critical current shows a periodic dependence with k_F (see Appendix C) and the corresponding fast Fourier transform (FFT) analysis [Fig. 3(f)] gives an oscillation period of $\Delta k_f \sim 4.01~\mu\mathrm{m}^{-1}$. An effective cavity

length $L_{\rm eff} \sim 780$ nm is then obtained from the FP resonance condition, i.e., $k_f L_{\rm eff} = n\pi$ (here we take n=1). The $L_{\rm eff}$ is slightly shorter than the channel length $\sim 1~\mu$ m, which is consistent with the existence of electron-doped regions near Nb contacts. The FP interferences also result in pronounced oscillations of the normal-state conductance G_n as a function of both V_g and V_{sd} under large negative gate voltages (see Appendix D). Remarkably, the oscillations of I_c with V_g do not match with the oscillations in G_n (see Appendix E), in contrast to observations in ballistic graphene Josephson junction [37,38].

The observation of the FP interference of the critical current in a micrometer-long Cd₃As₂ nanowire channel indicates that the supercurrent is of ballistic nature, i.e., the electrode separation is smaller than the elastic mean-free path. Given the fact that the mean-free path of bulk carriers in our samples is much smaller than the channel length $\sim 1 \,\mu \text{m}$ (see Appendix F), we can likely conclude that the supercurrent in the long junction is mainly carried by the surface states. The surface states may have a higher mobility due to the very different topology of the Fermi surface. The contribution of the surface states to transport in similar Cd₃As₂ nanowire was previously revealed by Aharonov-Bohm oscillations [8], benefiting from the large surface-to-volume ratio. Moreover, when the Fermi level is located near the Dirac point, the bulk conductions can be significantly suppressed due to the vanishing density of states at the Dirac point. The different oscillations in I_c and G_n may be attributed to the different conduction channels between the supercurrent and the normal conductance of the nanowire, where the supercurrent may be carried by surface states and the normal conductance is carried by both surface and bulk states. The surface states in a Dirac semimetal consist of two Fermi arcs, which connect the two surface projections of the bulk's Dirac points. For junction L, the increased electron carriers by tuning gate voltage not only enlarge the electron pockets, but also enhance the interaction between bulk and surface states, possibly also explaining the decrease of I_c as function of gate voltage.

To verify the ballistic nature of the Josephson supercurrent, the temperature dependence of I_c at different gate voltages was investigated (Fig. 4). By applying a gate voltage, it is possible to tune the transmission coefficient as well as the chemical potential and the ratio of surface/bulk contributions to transport. For junction A, the $I_c(T)$ dependence at $V_g = -80$ and -50 V shows a linear behavior [Fig. 4(a)]. At $V_g = -80$

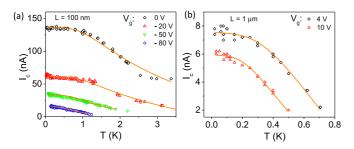


FIG. 4. Temperature dependence of the critical current. (a) The data for junction A at $V_g = 0$, -20, -50, and -80 V. (b) $I_c(T)$ for junction L at $V_g = 4$ and 10 V. The solid curves are the fitting results according to the ballistic short junction regime.

 $0\,\mathrm{V}$, the $I_c(T)$ dependence shows a concave behavior at high temperatures, and gradually saturates at low temperatures. In the short and ballistic limit, the critical supercurrent is given by [29,40]

$$I_c(\theta, \tau, T) = \max_{\theta} (\alpha \times \frac{\Delta}{eR_n} \times \frac{\sin \theta}{\sqrt{1 - \tau \sin^2 \theta / 2}} \times \tanh \left(\frac{\Delta}{2k_B T} \sqrt{1 - \tau \sin^2 \theta / 2} \right), \quad (1)$$

where τ is the transmission coefficient of the superconductornormal state interface, θ is the phase difference between the two superconducting electrodes, R_n is the normal resistance, and α corresponds to the reduction of I_c due to a nonideal environment. The temperature-dependent superconducting gap is assumed to be $\Delta \approx \Delta_0 \sqrt{1 - \left(\frac{T}{T_c}\right)^2}$, where Δ_0 is the gap as $T \to 0$, and T_c is the critical temperature. As the multiple Andreev reflections in our measurements are not distinct enough to determine Δ_0 , it was treated as a fitting parameter. At $V_g = 0 \,\text{V}$, the fitting results give $\tau = 0.37$, $\alpha = 0.40$, and $\Delta_0 = 0.36$ meV. For $V_g = -80$ V, the fitting results give $\tau = 0.23$, $\alpha = 0.32$, and $\Delta_0 = 0.14$ meV. The reduced transmission coefficient τ at -80 V is consistent with the observed Nb contact-induced n-type doping near the Cd₃As₂/Nb interface. The reduced gap Δ_0 is consistent with the decrease of the $I_c R_n$ product. Since the gate also influences the bulk contribution to R_n , especially when V_g approaches the Dirac point, the overall magnitude of I_c is changing with gate too. In the long-junction L, the $I_c(T)$ dependence shows that I_c at $V_g = 4 \text{ V}$ is always larger than at $V_g = 10 \text{ V}$ [Fig. 4(b)], which would be consistent with the fact that the surface carried supercurrent can be suppressed by the hybridization between surface and bulk states [13]. The observation of the FP oscillations indicates the supercurrent in junction L may also flow via ballistic transport, and Eq. (1) should be applicable to analyze the $I_c(T)$ dependence. As shown in Fig. 4(b), the fittings are in good agreement with the experimental data. The fitted superconducting gap Δ_0 is about 0.086 and 0.118 meV under $V_g = 10$ and 4 V, respectively. Given that $\Delta_0 \approx 1.76k_BT_c$, the corresponding critical temperature T_c at $V_g = 10$ and 4 V is 0.57 and 0.78 K, respectively, which is consistent with the extrapolated value from the $I_c(T)$ dependence. Such a convex saturating behavior of $I_c(T)$ dependence is similar to that observed in monolayer graphene vertical Josephson junction in the ballistic short-junction limit [40]. In the long-junction limit [29], the $I_c(T)$ dependence should have obeyed the exponential scaling $I_c \propto \exp(-k_B T/\delta E)$, where $\delta E \approx \hbar v_f/2\pi L$. The reason that our longest junction still can be fitted by short-junction theory is the combination of a large Fermi velocity and small induced gap value, resulting in a large coherence length of the order of the device length (see Appendix G).

IV. CONCLUSION

In summary, the proximity effect-induced supercurrent has been realized in Dirac semimetal Cd₃As₂ nanowire-based Josephson junctions. The superconductivity in Weyl/Dirac semimetals with nontrivial band structure of bulk Dirac/Weyl

nodes, as well as the Fermi arc surface states, is promising for the presence of Majorana bound states. This makes the combination of superconductivity and Weyl/Dirac semimetal attractive, opening an avenue for the search of topological superconductivity and Majorana fermions. Plainly, the realization of Josephson supercurrent through the surface state is an important step toward the observation of unconventional superconductors and Majorana bound states in such devices.

ACKNOWLEDGMENTS

We thank Hans Hilgenkamp for discussions and support. This work has been supported by National Key Research and Development Program of China (Grant No. 2016YFA0300802) and NSFC (Grant No. 11774004).

C.-Z.L., C.L., and L.-X.W. contributed equally to this work.

APPENDIX A: THE I_cR_n PRODUCT OF JUNCTION A

For junction A, the critical current I_c , normal-state resistance R_n , and the I_cR_n product as a function of gate voltage are shown in Fig. 5. The normal-state resistance R_n is deduced from the differential resistance at $I_{sd}=400$ nA. The I_cR_n product is nearly a constant as $V_g<-25$ V, while it fluctuates strongly with a nearly constant background as $V_g>-25$ V. The maximum of I_cR_n (248 μ V) yields a lower limit on the induced gap $I_cR_n\leqslant \frac{\Delta_i}{e}$. The coherent length $\xi=\frac{\hbar v_f}{\pi\Delta_i}$ thus can be estimated to be between 254 and 845 nm, according to the Fermi velocity in the range of $v_f\simeq 3\times 10^5-1\times 10^6$ m/s. Consequently, the transport in junction A should be close to the short-junction limit.

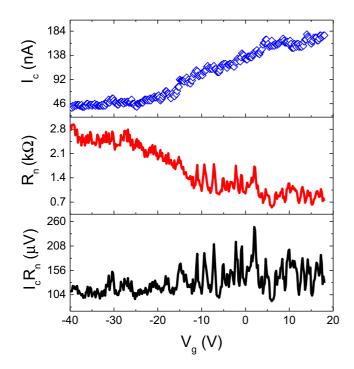


FIG. 5. Critical current, normal-state resistance, and their product $I_c R_n$ in junction A as a function of gate voltage.

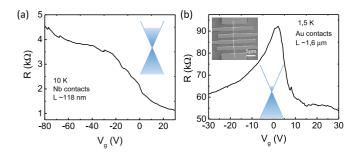


FIG. 6. (a) Gate-voltage dependence of resistance of individual Cd₃As₂ nanowire with Nb contacts measured at 10 K. The channel length is $\sim\!118$ nm. Inset: Schematic diagram of the Dirac cone shows the high Fermi level with highly electron doping. (b) Gate-voltage dependence of resistance of Cd₃As₂ nanowire with Au contacts measured at 1.5 K. The channel length is $\sim\!1.6~\mu m$. Top inset: SEM image of the device with Au contacts. Bottom inset: Schematic diagram of the Dirac cone shows the Fermi level close to the Dirac point.

APPENDIX B: ELECTRON DOPING EFFECT DUE TO Nb CONTACTS

Figures 6(a) and 6(b) show the transfer curves of individual Cd₃As₂ nanowire with Nb and Au contacts, respectively. The device with Nb contacts was measured at 10 K with a channel length ~118 nm, and the Dirac point is not observed even at $V_{g} = -80$ V. For comparison, the transfer curve of the nanowire with Au contacts measured at 1.5 K with a channel length $\sim 1.6 \ \mu m$ is displayed in Fig. 6(b). In contrast, the Dirac point of the device with Au contacts is near $V_{\rho} = 0 \text{ V}$, indicating that the Fermi level is very close to the Dirac point. The long channel length of the device with Au contacts makes the center part of the nanowire far from the influences of Au contacts, thus revealing the intrinsic property of the nanowire. Because the temperature difference could not result in such a big difference for the location of Dirac point, this comparison between junctions with Nb and Au contacts indicates the heavy electron doping of the Cd₃As₂ nanowire from the Nb contacts. Similar doping effect was also observed in graphene-based Josephson junctions.

For the gate modulation effect, the carrier concentration of the nanowire is obtained by $n = \frac{C}{l} \frac{1}{eS} (V_g - V_D)$, where $\frac{C}{l} = \frac{\pi \varepsilon_0 \varepsilon_r}{\cosh^{-1}(\frac{r+h}{2})}$, C is the capacitance of the oxide layer (SiO₂), $\varepsilon_r = 3.9$ is the relative dielectric constant of SiO₂, h = 285 nm is the SiO_2 thickness, r, l, and S are the radius, length, and cross-section area of the nanowire, respectively. When the Fermi level is near the Dirac point, the carriers can be modulated uniformly in the nanowire. For example, the transfer curve in Fig. 6(b) shows that the Dirac point V_D is ~ 2 V. The resistance decreases sharply when tuning the gate voltage positively (2 $< V_g < 10 \text{ V}$) or negatively (-30 $< V_g < 2 \text{ V}$), a clear indication of the gating effect. Considering the nanowire diameter d = 100 nm and channel length $L = 1.6 \mu m$, the carrier density induced by a gate voltage $V_g = 10 \, \mathrm{V}$ is estimated to be $n \sim 2.67 \times 10^{17} \mathrm{cm}^{-3}$, and the corresponding Fermi wave vector $k_f \sim 0.02/\text{Å}$. Based on the linear dispersion of Dirac semimetal, the rise of the Fermi energy $E_F = \hbar v_f k_f$ is around 39 \sim 131 meV by considering the Fermi velocity v_f

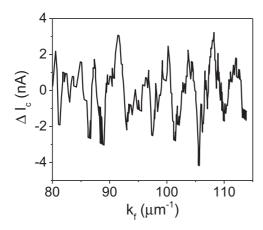


FIG. 7. ΔI_c oscillation as a function of k_f . The period Δk_f is $\sim 4.01 \, \mu \text{m}^{-1}$.

in the range of $0.3 \sim 1 \times 10^6$ m/s. While for $V_g > 15$ V, the resistance is almost invariant, indicating that the gating effect is ineffective due to the screening effect, as the nanowire is with high carrier density.

For junction A [Fig. 6(a)], the carriers are gradually reduced by tuning the gate voltage from $V_g=30$ to -80 V, leading to the increase of resistance. Although the gating capability in junction A may be weakened compared with that close to the Dirac point, the electrons can still be depleted by the negatively biased gate voltage even though the nanowire is heavily n-doped by Nb contacts.

APPENDIX C: THE I_ck_F OSCILLATIONS OF JUNCTION L

According to the transfer curve of junction L (Fig. 10), the Dirac point is roughly estimated to be $V_D = -1.5$ V, where the p-n junction is starting to be formed and the resistance changes most sharply. Therefore, the $I_c \sim V_g$ dependence can be converted to $I_c \sim k_f$ dependence according to the gate-induced carrier density and the band structures of ${\rm Cd}_3{\rm As}_2$ near the Dirac point. As shown in Fig. 7, the ΔI_c shows a periodic oscillation as a function of k_f in the range of $k_f \sim 95-115~\mu{\rm m}^{-1}$. The period of the $I_c(k_f)$ oscillation Δk_f is estimated to be \sim 4.01 $\mu{\rm m}^{-1}$, and the corresponding effective cavity length $L_{\rm eff} \sim 0.78~\mu{\rm m}$.

APPENDIX D: THE FABRY-PÉROT OSCILLATIONS IN G_N OF JUNCTION L

For the long-junction L, as tuned into the hole conduction regime by gate voltage, the p-n junctions form near the contacts due to the high electron doping near Nb contacts, resulting in the low transmission probability at the interfaces and small G_N . The partial reflection of electron waves at the interfaces creates a Fabry-Perot cavity. The standing waves lead to pronounced oscillations in conductance as a function of both V_g and applied bias V_{sd} . As shown in Fig. 8, an oblique stripe pattern (as marked with dashed lines) is observed, giving a characteristic of Fabry-Pérot oscillations. This pattern is only observed under negative gate voltage (n-p-n regime), while it disappears under positive gate voltage (n-n-n regime). We conclude that these

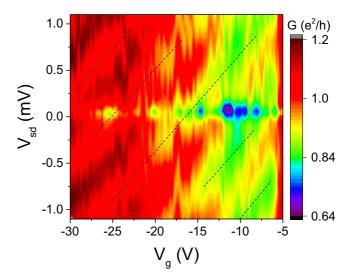


FIG. 8. Normal-state conductance as a function of voltage bias and gate voltage at 12 mK. The dashed lines indicate the oblique stripes, which give a signature of the Fabry-Perot interference.

oscillations indeed relate to the transmission probability at the interfaces.

APPENDIX E: THE COMPARISON BETWEEN I_c AND G_N FLUCTUATIONS AS A FUNCTION OF GATE VOLTAGE

The comparison between I_c and G_N (taken at $I_{sd} = 30 \, \mathrm{nA}$) fluctuations as a function of gate voltage, measured at 12 mK in junction L, is shown in Fig. 9. It is obvious that the patterns of $G_N(V_g)$ and $I_c(V_g)$ fluctuations are not in accordance with each other. This is greatly different from that observed in InAs/InSb nanowire junctions, in which the G_N and I_c fluctuations are almost synchronized. This disagreement in our system can be explained in a regime with different channels between I_c and G_N fluctuations. In such a micrometer-long channel of junction L, the supercurrent is likely carried by surface states, because the bulk states are nearly decoherent through the entire nanowire. Thus, only the superconducting surface states

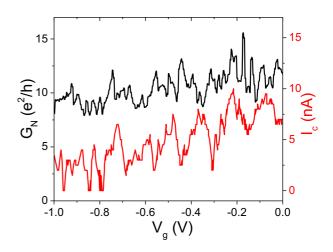


FIG. 9. Normal-state conductance G_n and critical current I_c plotted as a function of gate voltage V_g , measured at 12 mK in junction L.

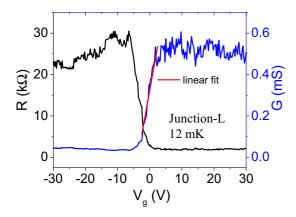


FIG. 10. Gate-voltage dependence of resistance and conductance in junction L measured at 12 mK and at $I_{sd} = 50 \, \text{nA}$ in a normal state. The red line is the linear fit of $G(V_g)$ curve in the region near $V_g = 0 \, \text{V}$.

contribute to the I_c fluctuations, while both surface and bulk states should contribute to the G_N fluctuations.

APPENDIX F: THE MOBILITY AND MEAN-FREE PATH CALCULATED FROM $G(V_g)$ CHARACTERISTICS

The carrier mobility and mean-free path of the nanowire can be estimated from the $G(V_g)$ characteristics. Figure 10 shows the gate-voltage dependence of normal-state resistance and conductance of junction L, measured at 12 mK with $I_{sd}=50\,\mathrm{nA}$ in a normal state. From the linear fit (red line) of $G(V_g)$ curve in the region near $V_g=0$ V, the mobility is calculated to be $\mu_e\sim 2.05\times 10^4\,\mathrm{cm}^2/\mathrm{Vs}$. The mean-free path $l_e=v_f\frac{m^*\mu_e}{e}$ is estimated to be about 467 nm by considering $v_f=1\times 10^6\,\mathrm{m/s}$ and $m^*=0.04m_e$. Considering the high electron doping near Nb contacts, below $V_g=0$ V the hole conduction in the center part and the p-n junction formation near the contacts may also contribute to the sharp increase of

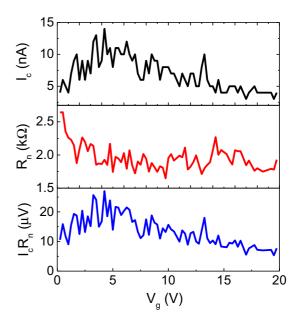


FIG. 11. Critical current, normal-state resistance, and their product $I_c R_n$ in junction L as a function of gate voltage.

resistance. Therefore, the mobility and mean-free path may be overestimated. For short-junction A and B, the heavily doped region from Nb contacts nearly extends to the whole channel, thus the gate modulation capability would be reduced due to the screening effect.

APPENDIX G: THE $I_C R_n$ PRODUCT OF JUNCTION L

For junction L, the critical current I_c , normal-state resistance R_n , and the I_cR_n product as a function of gate voltage are shown in Fig. 11. The I_CR_n is not a constant but varies from 5 to 25 μ V. Considering $I_cR_n \leqslant \frac{\Delta_i}{e}$, the coherence length $\xi = \frac{\hbar v_f}{\pi \Delta_i}$ is estimated to be larger than the channel length 1 μ m, due to the large Fermi velocity in the range of $v_f \simeq 3 \times 10^5 - 1 \times 10^6$ m/s.

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